

Special Issue

Photonics in BioMedical Progress

Message from the Guest Editor

This special issue is dedicated to compile a collection the novel approaches of research or review results from a broad category related to the application of biomedical engineering with Photonics. Since the main goal of present special issue is to introduce the demonstration of convergence between biomedical engineering and various technologies of photonics, the topics are appropriate to show the results of the utilization of photonics for various bio medical engineering related purposed such as treatment or diagnosis. And the techniques related to photonics are described below. **Keywords** LASER therapeutics, LASER, Imaging sensor, Colorimetric sensor, Plasmonics, Photo-acoustics, Fiber optics, Opto-electronics, Optical modulations and others related to photonics

Guest Editor

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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